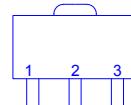
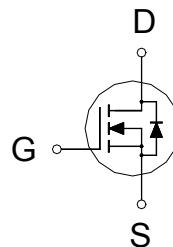


NIKO-SEM
**N-Channel Enhancement Mode
Field Effect Transistor**
PA910BC
SOT-89
Halogen-Free & Lead-Free
PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
100V	190mΩ	2.9A


 1: GATE
 2: DRAIN
 3: SOURCE
ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS	UNITS
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	2.9	A
		2.3	
Pulsed Drain Current ¹	I_{DM}	8	
Power Dissipation ³	P_D	3.9	W
		2.5	
Operating Junction & Storage Temperature Range	T_j, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ²	$R_{\theta JA}$		32	°C/W
Junction-to-Ambient ²	Steady-State		60	
Junction-to-Case	$R_{\theta JC}$		7.8	

¹Pulse width limited by maximum junction temperature.

²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

³The Power dissipation is based on $R_{\theta JA}$ t $\leq 10\text{s}$ value.
ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	100			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.3	1.9	2.3	

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Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 80V, V_{GS} = 0V$			1	μA
		$V_{DS} = 80V, V_{GS} = 0V, T_J = 100^\circ C$			10	
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 1.6A$		148	190	$m\Omega$
		$V_{GS} = 4.5V, I_D = 1.6A$		159	205	
Forward Transconductance ¹	g_{fs}	$V_{DS} = 5V, I_D = 1.6A$		7		s
DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		301		pF
Output Capacitance	C_{oss}			29		
Reverse Transfer Capacitance	C_{rss}			19		
Gate Resistance	R_g	$V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$		2.3		Ω
Total Gate Charge ²	Q_g	$V_{DS} = 50V, V_{GS} = 10V, I_D = 1.6A$		8.1		nC
Gate-Source Charge ²	Q_{gs}			0.9		
Gate-Drain Charge ²	Q_{gd}			3.1		
Turn-On Delay Time ²	$t_{d(on)}$			6		
Rise Time ²	t_r	$V_{DD} = 50V, I_D \approx 1.6A, V_{GEN} = 10V, R_{GS} = 6\Omega$		23		nS
Turn-Off Delay Time ²	$t_{d(off)}$			15		
Fall Time ²	t_f			22		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ C$)						
Continuous Current	I_S				0.9	A
Forward Voltage ¹	V_{SD}	$I_F = 1.6A, V_{GS} = 0V$			1.4	V
Reverse Recovery Time	t_{rr}	$I_F = 1.6A, dI_F/dt = 100A/\mu S$		17.8		nS
Reverse Recovery Charge	Q_{rr}			8.8		nC

¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.

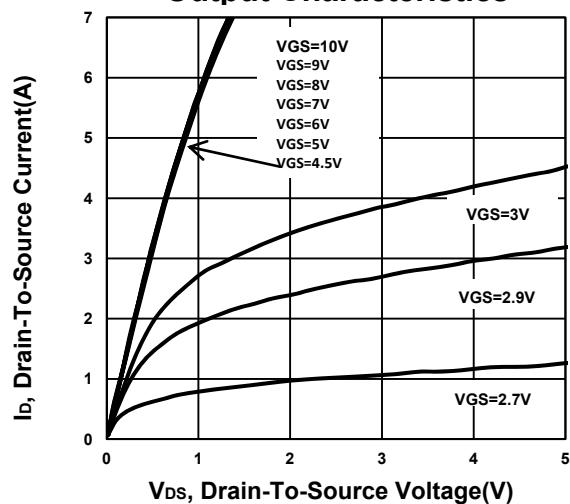
²Independent of operating temperature

NIKO-SEM

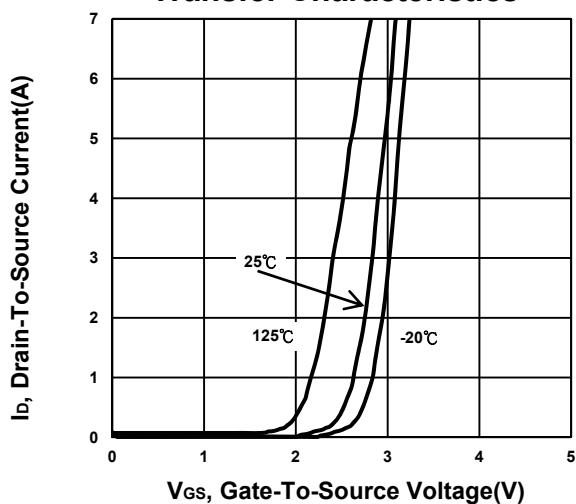
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Field Effect Transistor**

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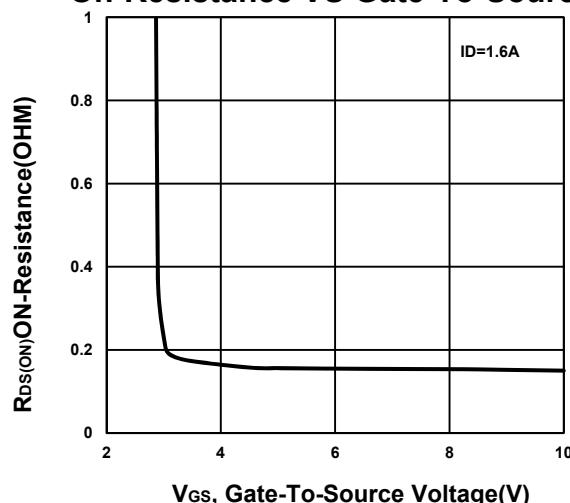
Output Characteristics



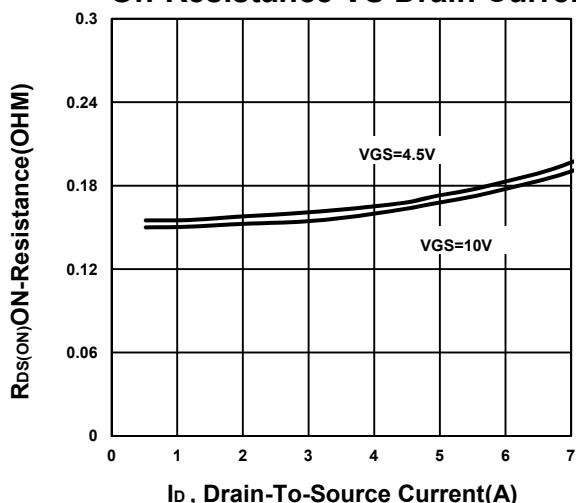
Transfer Characteristics



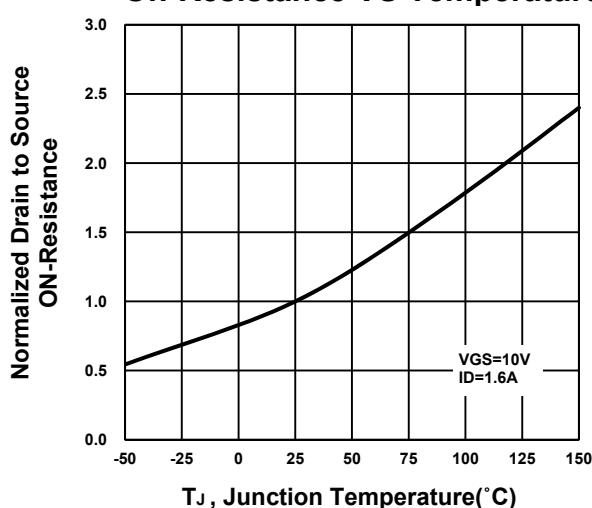
On-Resistance VS Gate-To-Source



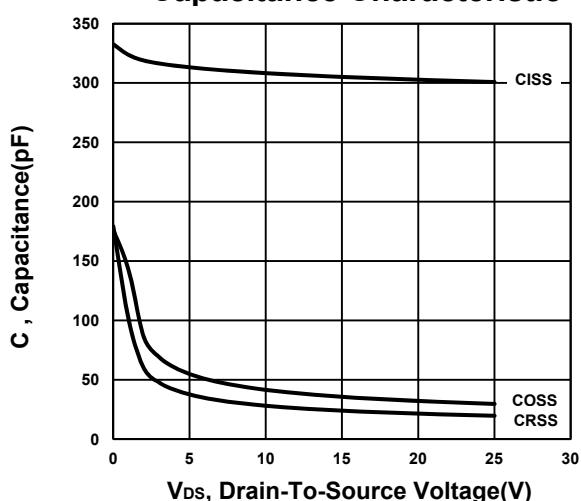
On-Resistance VS Drain Current



On-Resistance VS Temperature



Capacitance Characteristic

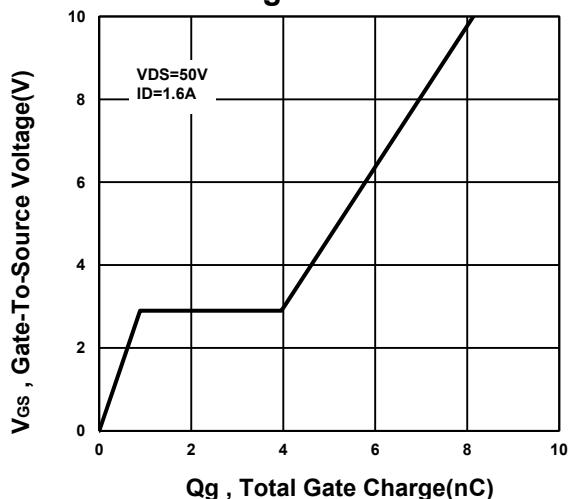


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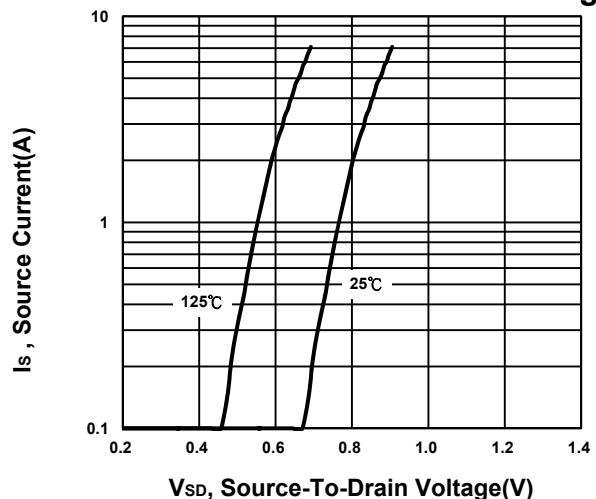
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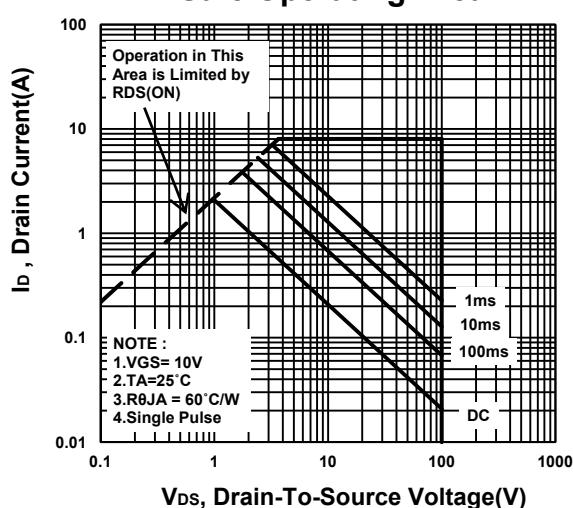
Gate charge Characteristics



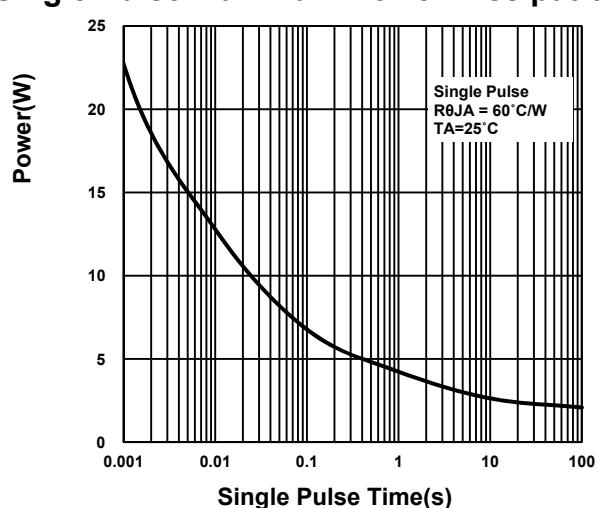
Source-Drain Diode Forward Voltage



Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve

